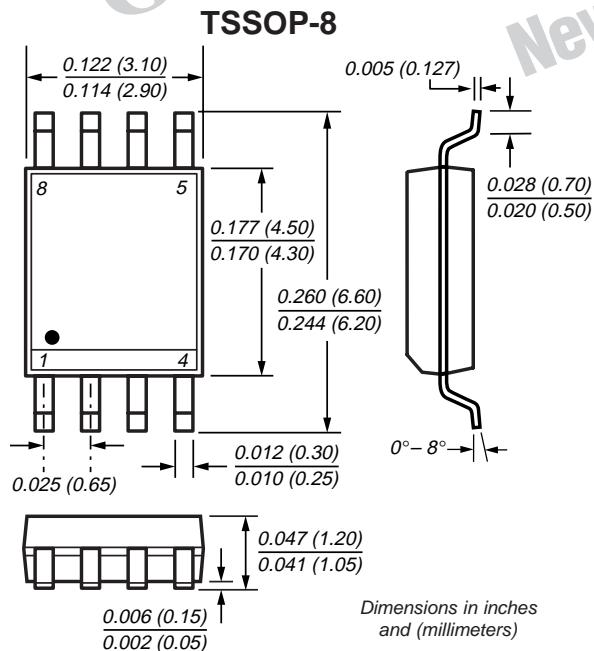


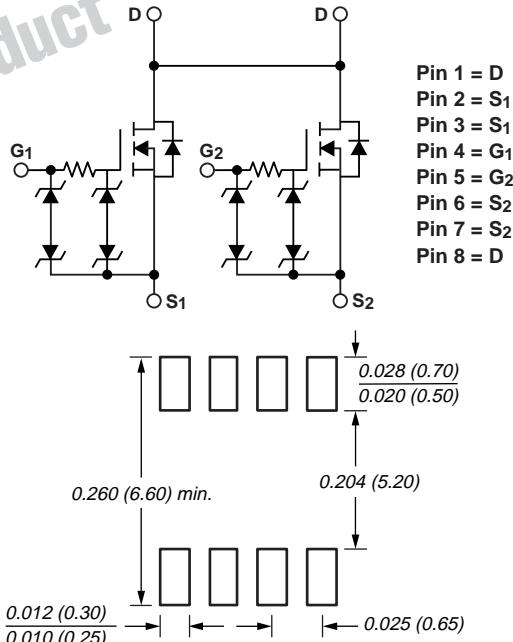


TRENCH
GENFET®



Battery Switch, ESD Protected Common-Drain Dual N-Channel MOSFET

Low V_{GS(th)} V_{DS} 20V R_{DS(ON)} 22mΩ I_D 6.5A



Mechanical Data

Case: TSSOP-8 Package

Terminals: Leads solderable per MIL-STD-750, Method 2026

High temperature soldering guaranteed:
250°C/10 seconds at terminals

Mounting Position: Any

Weight: 0.5g

Features

- Advanced Trench Process Technology
- High Density Cell Design for Ultra Low On-Resistance
- Specially Designed for Li-ion battery packs use
- Designed for battery-switch applications

Maximum Ratings and Thermal Characteristics (T_A = 25°C unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	20	V
Gate-Source Voltage	V _{GS}	±12	
Continuous Drain Current (T _J = 150°C) ⁽¹⁾	I _D	6.5	A
Pulsed Drain Current	I _{DM}	30	A
Maximum Power Dissipation ⁽¹⁾	P _D	1.5 0.96	W
Operating Junction and Storage Temperature Range	T _J , T _{stg}	-55 to 150	°C
Maximum Junction-to-Ambient ⁽¹⁾ Thermal Resistance	R _{θJA}	83	°C/W

Notes: (1) Surface mounted on FR4 board, t ≤ 10 sec.

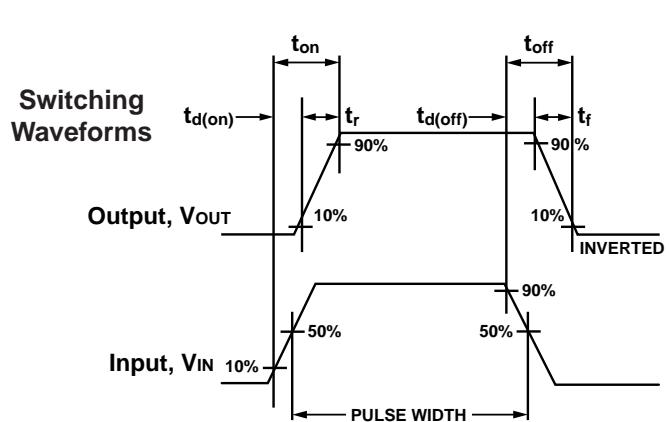
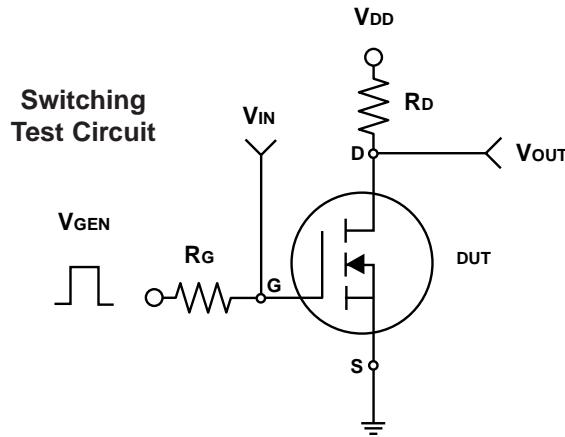
Battery Switch, ESD Protected Common-Drain Dual N-Channel MOSFET

Electrical Characteristics ($T_J = 25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Static						
Drain-Source Breakdown Voltage	BV_{DSS}	$\text{V}_{\text{GS}} = 0\text{V}, \text{I}_D = 250\mu\text{A}$	20	—	—	V
Gate Threshold Voltage	$\text{V}_{\text{GS(th)}}$	$\text{V}_{\text{DS}} = \text{V}_{\text{GS}}, \text{I}_D = 250\mu\text{A}$	0.60	0.85	—	V
Gate Body Leakage	I_{GSS}	$\text{V}_{\text{GS}} = \pm 12\text{V}, \text{V}_{\text{DS}} = 0\text{V}$	—	—	± 10	μA
Zero Gate Voltage Drain Current	I_{DSS}	$\text{V}_{\text{DS}} = 20\text{V}, \text{V}_{\text{GS}} = 0\text{V}$	—	—	1	μA
On-State Drain Current ⁽¹⁾	$\text{I}_{\text{D(on)}}$	$\text{V}_{\text{DS}} \geq 5\text{V}, \text{V}_{\text{GS}} = 4.5\text{V}$	30	—	—	A
Drain-Source On-State Resistance ⁽¹⁾	$\text{R}_{\text{DS(on)}}$	$\text{V}_{\text{GS}} = 4.5\text{V}, \text{I}_D = 6.5\text{A}$	—	17.5	22	$\text{m}\Omega$
		$\text{V}_{\text{GS}} = 2.5\text{V}, \text{I}_D = 5.5\text{A}$	—	22	30	
Forward Transconductance ⁽¹⁾	g_{fs}	$\text{V}_{\text{DS}} = 10\text{V}, \text{I}_D = 6.5\text{A}$	—	30	—	S
Dynamic						
Total Gate Charge	Q_g	$\text{V}_{\text{DS}} = 10\text{V}, \text{V}_{\text{GS}} = 4.5\text{V}$ $\text{I}_D = 6.5\text{A}$	—	15.5	30	nC
Gate-Source Charge	Q_{gs}		—	2.0	—	
Gate-Drain Charge	Q_{gd}		—	3.5	—	
Turn-On Delay Time	$t_{\text{d(on)}}$	$\text{V}_{\text{DD}} = 10\text{V}, \text{R}_L = 10\Omega$ $\text{I}_D = 1\text{A}, \text{V}_{\text{GEN}} = 4.5\text{V}$ $\text{R}_G = 6\Omega$	—	0.45	0.60	μs
Turn-On Rise Time	t_r		—	0.65	0.85	
Turn-Off Delay Time	$t_{\text{d(off)}}$		—	4.5	6.0	
Fall Time	t_f		—	1.7	2.2	
Input Capacitance ⁽¹⁾	C_{iss}	$\text{V}_{\text{DS}} = 10\text{V}, \text{V}_{\text{GS}} = 0\text{V}$ $f = 1.0 \text{ MHz}$	—	1360	—	pF
Output Capacitance ⁽¹⁾	C_{oss}		—	220	—	
Reverse Transfer Capacitance ⁽¹⁾	Crss		—	130	—	
Source-Drain Diode						
Maximum Diode Forward Current	I_s	—	—	—	1.5	A
Diode Forward Voltage	V_{SD}	$\text{I}_s = 1.5\text{A}, \text{V}_{\text{GS}} = 0\text{V}$	—	0.61	1.2	V

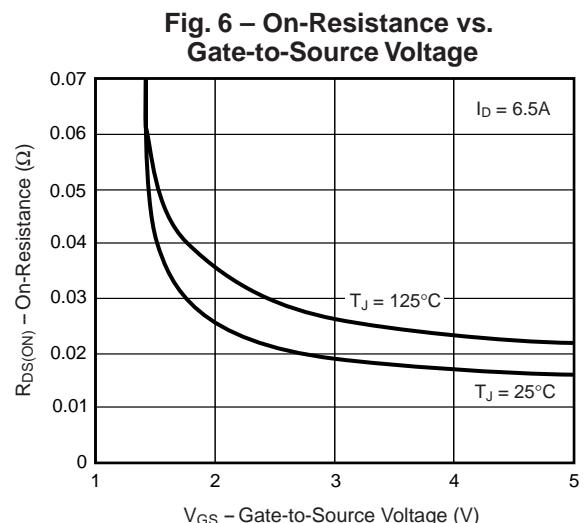
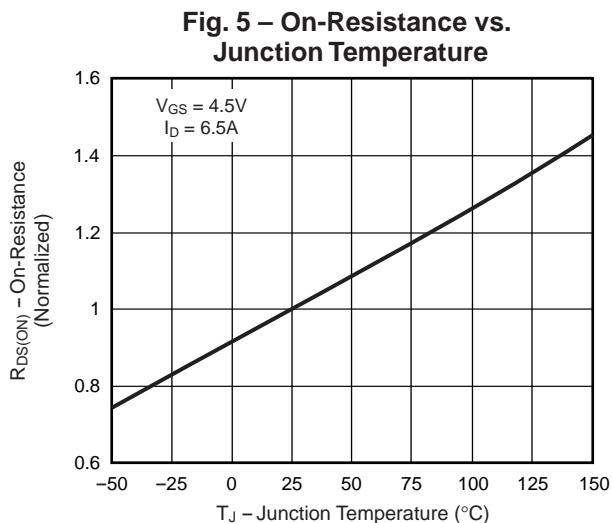
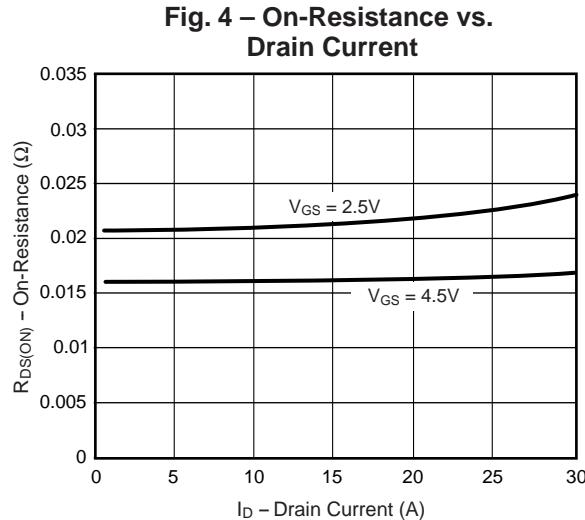
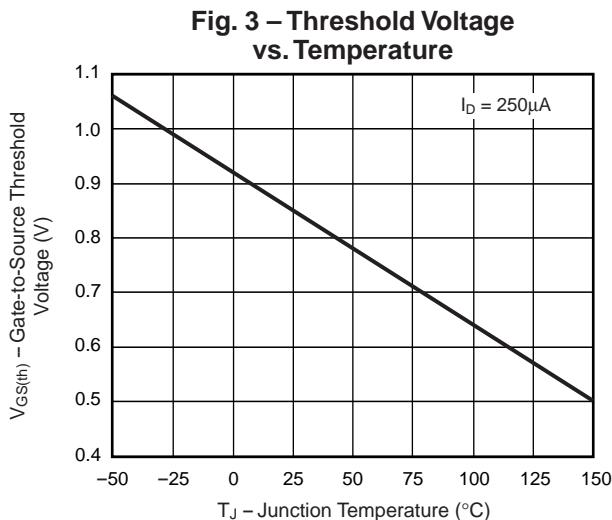
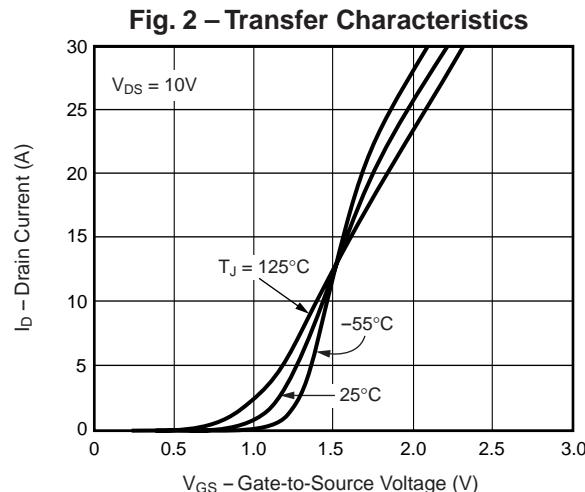
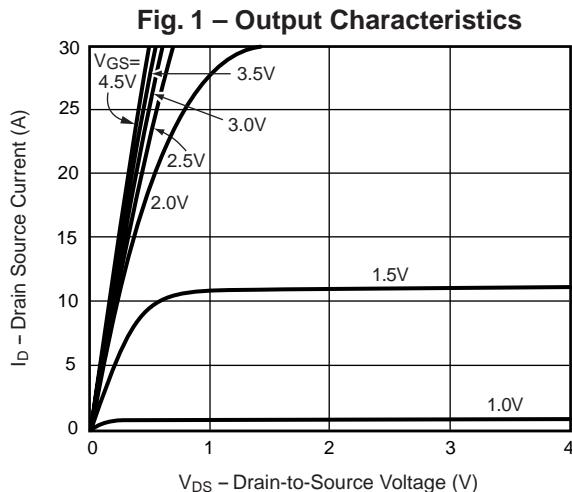
Notes: (1) Pulse test; pulse width $\leq 300 \mu\text{s}$, duty cycle $\leq 2\%$

(2) For MOSFET portion only



Ratings and
Characteristic Curves ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Battery Switch, ESD Protected
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Characteristic Curves** ($T_A = 25^\circ\text{C}$ unless otherwise noted)

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